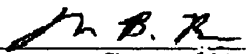
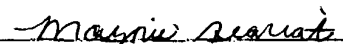


1765
75
5-3-02

Change Of Attorney Or Agent's Address In Application (37 CFR 1.8(a))			Docket No. 004227USA02/ETCH/SILICON
In Re Application Of: David S. Mul et al. J82			
Serial No. 09/905,172	Filing Date 07/13/01	Examiner Unassigned	Group Art Unit 1768
Invention: ETCH PATTERN DEFINITION USING A CVD ORGANIC LAYER AS AN ANTI-REFLECTION COATING AND HARDMASK			
<u>TO THE ASSISTANT COMMISSIONER FOR PATENTS</u>			
<p>Please send all correspondence for this application to:</p> <p>Patent Counsel, MS/2061 Legal Affairs Department Applied Materials, Inc. P.O. Box 450A Santa Clara, CA 95052</p> <p>Please direct all telephone calls to:</p> <p>Joseph Bach 408-584-3155</p> <p style="text-align: right;">RECEIVED APR 24 2002 TC 1700</p> <p style="text-align: right;">COPY OF PAPERS ORIGINALLY FILED</p>			
 _____ Signature of Attorney or Agent of Record		Dated: April 11, 2002	
<p>David B. Bonham Reg. No. 34,297</p> <p>Mayer Fortkort & Williams, PC 251 North Avenue West, 2nd Floor Westfield, NJ 07090</p> <p>Registration Number & Address of Attorney or Agent of Record</p>		<p>I certify that this document is being deposited on 4/11/02 with the U.S. Postal Service as first class mail under 37 C.F.R. 1.8 and is addressed to the Assistant Commissioner for Patents, Washington, D.C. 20231.</p> <p> _____ Signature of Person Mailing Correspondence</p> <p>Marjorie Scarlati Typed or Printed Name of Person Mailing Correspondence</p>	